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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Ray *et al.*

Examiner: Nguyen, Ha T

Serial No.: 09/779,812

Art Unit: 2812

Filed: 2/08/01

For: LEAD-FREE SOLDER STRUCTURE AND METHOD FOR HIGH FATIGUE LIFECommissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450**AMENDMENT**

Sir:

In response to the Final Office Action mailed June 24, 2003, please amend the above-identified application as follows:

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AUG 15 2003

TECHNOLOGY CENTER 2800

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